TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (Ultra High speed U-MOSIII)

TPC8017-H

High Speed and High Efficiency DC-DC Converters Notebook PC Applications Portable Equipment Applications

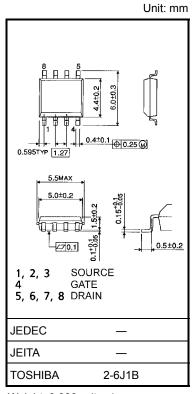
- Small footprint due to small and thin package
- High speed switching
- Small gate charge: $Q_g = 25 \text{ nC (typ.)}$
- Low drain-source ON resistance: RDS (ON) = $5.1 \text{ m}\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 38 S$ (typ.)
- Low leakage current: $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement mode: $V_{th} = 1.1 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	30	V
Drain-gate voltage (R	$R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	30	V
Gate-source voltage		V _{GSS}	±20	V
Drain current	DC (Note 1)	ID	15	Α
	Pulsed (Note 1)	I _{DP}	60	A
Drain power dissipati	on $(t = 10 s)$ (Note 2a)	P_{D}	1.9	W
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.0	W
Single pulse avalance	ne energy (Note 3)	E _{AS}	146	mJ
Avalanche current		I _{AR}	15	Α
Repetitive avalanche	energy Note 2a) (Note 4)	E _{AR}	0.19	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature	range	T _{stg}	-55 to 150	°C

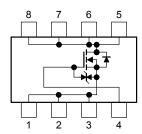
Note: For (Note 1), (Note 2), (Note 3), (Note 4), please refer to the next page.

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 0.080 g (typ.)

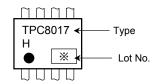
Circuit Configuration



Thermal Characteristics

Characteristics		Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2	2a)	R _{th (ch-a)}	65.8	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)		R _{th (ch-a)}	125	°C/W

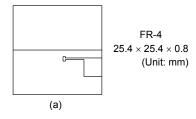
Marking (Note 5)

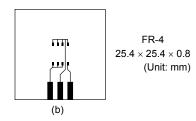


Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



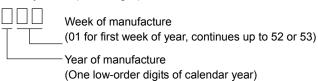


Note 3: $V_{DD} = 24~V,~T_{ch} = 25^{\circ}C$ (initial), L = 0.5 mH, R_G = 25 $\Omega,~I_{AR} = 15~A$

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: • on lower left of the marking indicates Pin 1.

* Weekly code: (Three digits)

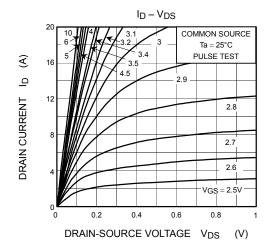


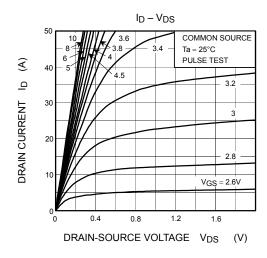
Electrical Characteristics (Ta = 25°C)

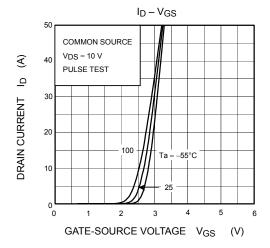
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-OFF cu	rrent	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	10	μА
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$		_	_	V
		V _{(BR) DSX}	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	_	_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.1	_	2.3	V
Drain-source ON resistance		Dec (cu)	V _{GS} = 4.5 V, I _D = 7.5 A	_	7.3	9.5	mΩ
		R _{DS} (ON)	V _{GS} = 10 V, I _D = 7.5 A	_	5.1	6.6	
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 7.5 A	19	38	_	S
Input capacitance		C _{iss}		_	1465	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	175	_	pF
Output capacitance		Coss	_	_	610	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10}{\underset{0}{\text{V}}} \bigvee \qquad I_{D} = 7.5 \text{ A}$	_	4	_	
	Turn-ON time	t _{on}		_	11	_	- ns
	Fall time	t _f		_	10	_	
	Turn-OFF time	ime t_{off} Duty \leq 1%, t_{W} = 10 μs		_	38	_	
Total gate charge (gate-source plus gate-drain)			$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	_	25	_	
		Qg	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 15 \text{ A}$	_	14	_	nC
Gate-source charge 1		Q _{gs1}		_	4.7	_	
Gate-drain ("miller") charge		Q _{gd}	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	_	5.7	_	
Gate switch charge		Q _{SW}		_	7.8	_	

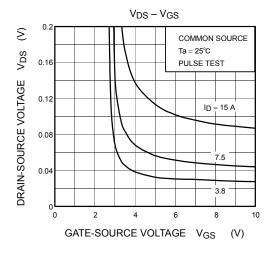
Source-Drain Ratings and Characteristics (Ta = 25°C)

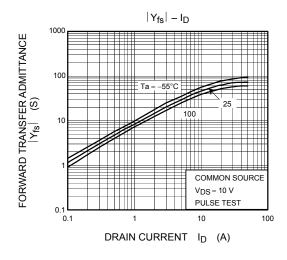
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	60	Α
Forward voltage (diode)			V_{DSF}	I _{DR} = 15 A, V _{GS} = 0 V	_	_	-1.2	V

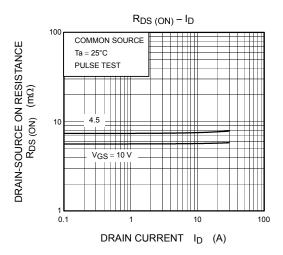


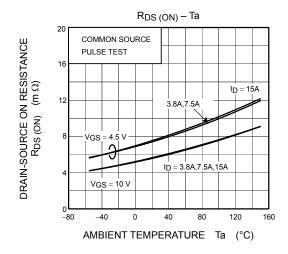


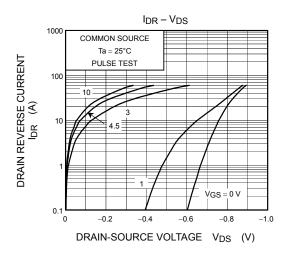


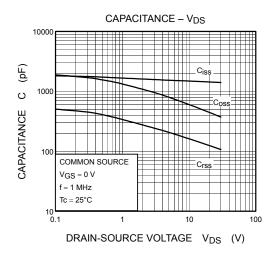


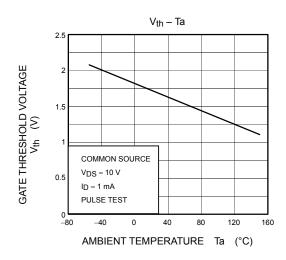


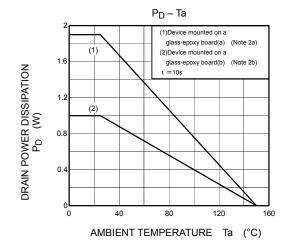


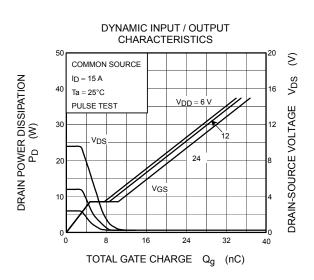




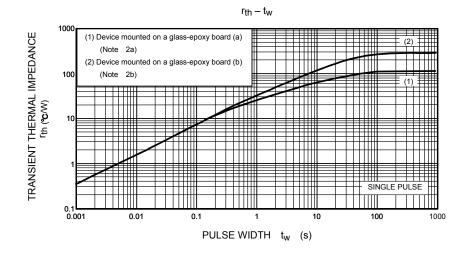


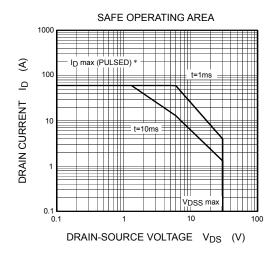






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